

# MC74HCT273A

## Octal D Flip-Flop with Common Clock and Reset with LSTTL-Compatible Inputs

### High-Performance Silicon-Gate CMOS

The MC74HCT273A may be used as a level converter for interfacing TTL or NMOS outputs to High-Speed CMOS inputs.

The HCT273A is identical in pinout to the LS273.

This device consists of eight D flip-flops with common Clock and Reset inputs. Each flip-flop is loaded with a low-to-high transition of the Clock input. Reset is asynchronous and active low.

#### Features

- Output Drive Capability: 10 LSTTL Loads
- TTL/NMOS Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 4.5 V to 5.5 V
- Low Input Current: 1.0  $\mu$ A
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 284 FETs or 71 Equivalent Gates
- These Devices are Pb-Free and are RoHS Compliant

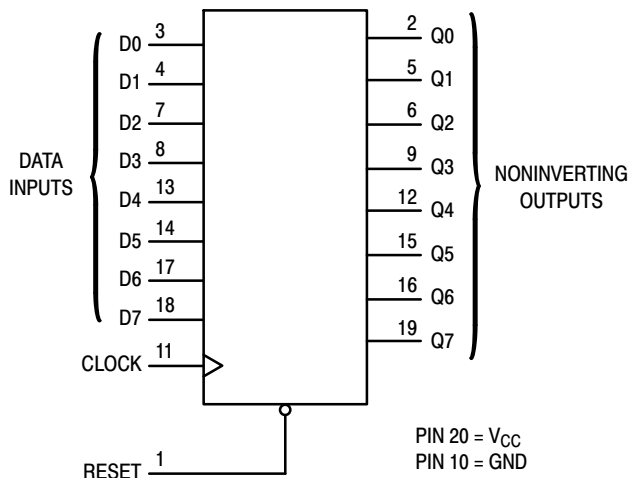
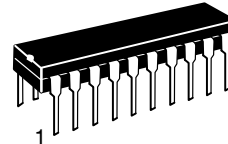


Figure 1. Logic Diagram

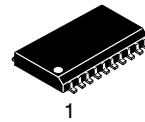


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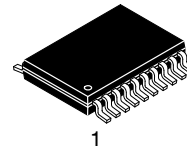
<http://onsemi.com>



PDIP-20  
N SUFFIX  
CASE 738



SOIC-20W  
DW SUFFIX  
CASE 751D



TSSOP-20  
DT SUFFIX  
CASE 948E

#### PIN ASSIGNMENT

|       |    |    |                 |
|-------|----|----|-----------------|
| RESET | 1  | 20 | V <sub>CC</sub> |
| Q0    | 2  | 19 | Q7              |
| D0    | 3  | 18 | D7              |
| D1    | 4  | 17 | D6              |
| Q1    | 5  | 16 | Q6              |
| Q2    | 6  | 15 | Q5              |
| D2    | 7  | 14 | D5              |
| D3    | 8  | 13 | D4              |
| Q3    | 9  | 12 | Q4              |
| GND   | 10 | 11 | CLOCK           |

#### FUNCTION TABLE

| Inputs |                    |   | Output    |
|--------|--------------------|---|-----------|
| Reset  | Clock              | D | Q         |
| L      | X                  | X | L         |
| H      | $\nearrow$         | H | H         |
| H      | $\searrow$         | L | L         |
| H      | L                  | X | No Change |
| H      | $\curvearrowright$ | X | No Change |

X = Don't Care  
Z = High Impedance

#### ORDERING INFORMATION

See detailed ordering, shipping information, and marking information in the package dimensions section on page 5 of this data sheet.

# MC74HCT273A

## MAXIMUM RATINGS

| Symbol    | Parameter   | Value                   | Unit |
|-----------|---|-------------------------|------|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)                             | - 0.5 to + 7.0          | V    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)                              | - 0.5 to $V_{CC} + 0.5$ | V    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)                             | - 0.5 to $V_{CC} + 0.5$ | V    |
| $I_{in}$  | DC Input Current, per Pin   | $\pm 20$                | mA   |
| $I_{out}$ | DC Output Current, per Pin  | $\pm 25$                | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                          | $\pm 50$                | mA   |
| $P_D$     | Power Dissipation in Still Air<br>PDIP†<br>SOIC Package†          | 750<br>500              | mW   |
| $T_{stg}$ | Storage Temperature   | - 65 to + 150           | °C   |
| $T_L$     | Lead Temperature, 1 mm from Case for 10 Seconds<br>(SOIC or PDIP) | 260                     | °C   |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating — Plastic DIP: - 10 mW/°C from 65° to 125°C  
SOIC Package: - 7 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

| Symbol            | Parameter  | Min  | Max      | Unit |
|-------------------|--|------|----------|------|
| $V_{CC}$          | DC Supply Voltage (Referenced to GND)                | 4.5  | 5.5      | V    |
| $V_{in}, V_{out}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0    | $V_{CC}$ | V    |
| $T_A$             | Operating Temperature, All Package Types             | - 55 | + 125    | °C   |
| $t_r, t_f$        | Input Rise and Fall Time (Figure 1)                  | 0    | 500      | ns   |

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Test Conditions   | $V_{CC}$<br>V | Guaranteed Limit         |  |                          | Unit          |
|-----------------|--|---|---------------|--------------------------|--|--------------------------|---------------|
|                 |  |   |               | - 55 to<br>25°C          | $\leq 85^\circ\text{C}$                  | $\leq 125^\circ\text{C}$ |               |
| $V_{IH}$        | Minimum High-Level Input Voltage               | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 4.5           | 2.0                      | 2.0                                      | 2.0                      | V             |
|                 |  |   | 5.5           | 2.0                      | 2.0                                      | 2.0                      |               |
| $V_{IL}$        | Maximum Low-Level Input Voltage                | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 4.5           | 0.8                      | 0.8                                      | 0.8                      | V             |
|                 |  |   | 5.5           | 0.8                      | 0.8                                      | 0.8                      |               |
| $V_{OH}$        | Minimum High-Level Output Voltage              | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$   | 4.5           | 4.4                      | 4.4                                      | 4.4                      | V             |
|                 |  |   | 5.5           | 5.4                      | 5.4                                      | 5.4                      |               |
| $V_{OL}$        | Maximum Low-Level Output Voltage               | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 4.0 \text{ mA}$   | 4.5           | 3.98                     | 3.84                                     | 3.7                      | V             |
|                 |  |   | 5.5           | 0.1                      | 0.1                                      | 0.1                      |               |
| $I_{in}$        | Maximum Input Leakage Current                  | $V_{in} = V_{CC} \text{ or } GND$   | 4.5           | 0.1                      | 0.1                                      | 0.1                      | $\mu\text{A}$ |
|                 |  |   | 5.5           | 0.1                      | 0.1                                      | 0.1                      |               |
| $I_{CC}$        | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$<br>$I_{out} = 0 \mu\text{A}$  | 4.5           | $\pm 0.1$                | $\pm 1.0$                                | $\pm 1.0$                | $\mu\text{A}$ |
|                 |  |   | 5.5           | 4.0                      | 40                                       | 160                      |               |
| $\Delta I_{CC}$ | Additional Quiescent Supply Current            | $V_{in} = 2.4 \text{ V, Any One Input}$<br>$V_{in} = V_{CC} \text{ or } GND, \text{ Other Inputs}$<br>$I_{out} = 0 \mu\text{A}$ | 5.5           | $\geq -55^\circ\text{C}$ | $25^\circ\text{C to } 125^\circ\text{C}$ |                          | mA            |
|                 |  |   |               | 2.9                      | 2.4                                      |                          |               |

# MC74HCT273A

## AC ELECTRICAL CHARACTERISTICS ( $V_{CC} = 5.0\text{ V} \pm 10\%$ , $C_L = 50\text{ pF}$ , Input $t_r = t_f = 6.0\text{ ns}$ )

| Symbol                   | Parameter                                  | Fig. | Guaranteed Limit |        |         | Unit |
|--------------------------|--|------|------------------|--------|---------|------|
|                          |  |      | - 55 to 25°C     | ≤ 85°C | ≤ 125°C |      |
| $f_{\max}$               | Maximum Clock Frequency (50% Duty Cycle)   | 2, 5 | 30               | 24     | 20      | MHz  |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Maximum Propagation Delay, Clock to Q      | 2, 5 | 25               | 28     | 35      | ns   |
| $t_{PHL}$                | Maximum Propagation Delay, Reset to Q      |      | 25               | 28     | 35      | ns   |
| $t_{TLH}$ ,<br>$t_{THL}$ | Maximum Output Transition Time, Any Output | 2, 5 | 18               | 20     | 22      | ns   |

| $C_{PD}$ | Power Dissipation Capacitance (Per Gate)* | Typical @ 25°C, $V_{CC} = 5.0\text{ V}$ |  | pF |
|----------|---|---|--|----|
|          |   | 30                                      |  |    |
|          |   |   |  |    |

\* Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

## TIMING REQUIREMENTS ( $V_{CC} = 5.0\text{ V} \pm 10\%$ , $C_L = 50\text{ pF}$ , Input $t_r = t_f = 6.0\text{ ns}$ )

| Symbol     | Parameter   | Fig. | Guaranteed Limit |     |        |     |         |     | Unit |
|------------|---|------|------------------|-----|--------|-----|---------|-----|------|
|            |   |      | - 55 to 25°C     |     | ≤ 85°C |     | ≤ 125°C |     |      |
|            |   |      | Min              | Max | Min    | Max | Min     | Max |      |
| $t_{su}$   | Minimum Setup Time, Data to Clock                     |      | 10               |     | 12     |     | 15      |     | ns   |
| $t_h$      | Minimum Hold Time, Clock to Data                      |      | 3.0              |     | 3.0    |     | 3.0     |     | ns   |
| $t_{rec}$  | Minimum Recovery Time, Set or Reset Inactive to Clock |      | 5.0              |     | 5.0    |     | 5.0     |     | ns   |
| $t_w$      | Minimum Pulse Width, Clock                            | 2    | 12               |     | 15     |     | 18      |     | ns   |
| $t_w$      | Minimum Pulse Width, Set or Reset                     |      | 12               |     | 15     |     | 18      |     | ns   |
| $t_r, t_f$ | Maximum Input Rise and Fall Times                     | 2    |                  | 500 |        | 500 |         | 500 | ns   |

## SWITCHING WAVEFORMS

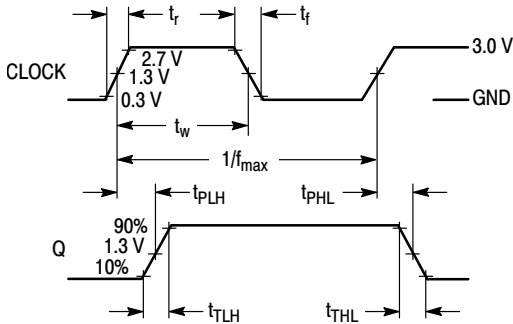


Figure 2.

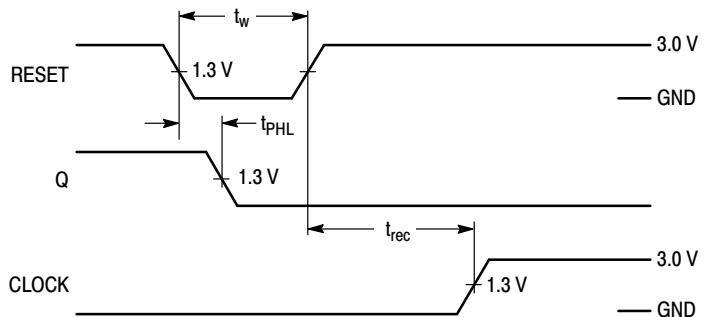


Figure 3.

# MC74HCT273A

## SWITCHING WAVEFORMS

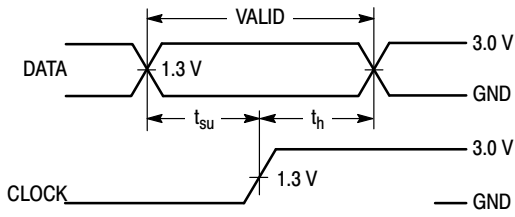
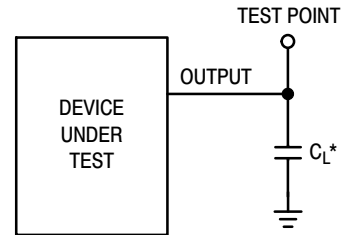


Figure 4.



\*Includes all probe and jig capacitance

Figure 5. Test Circuit

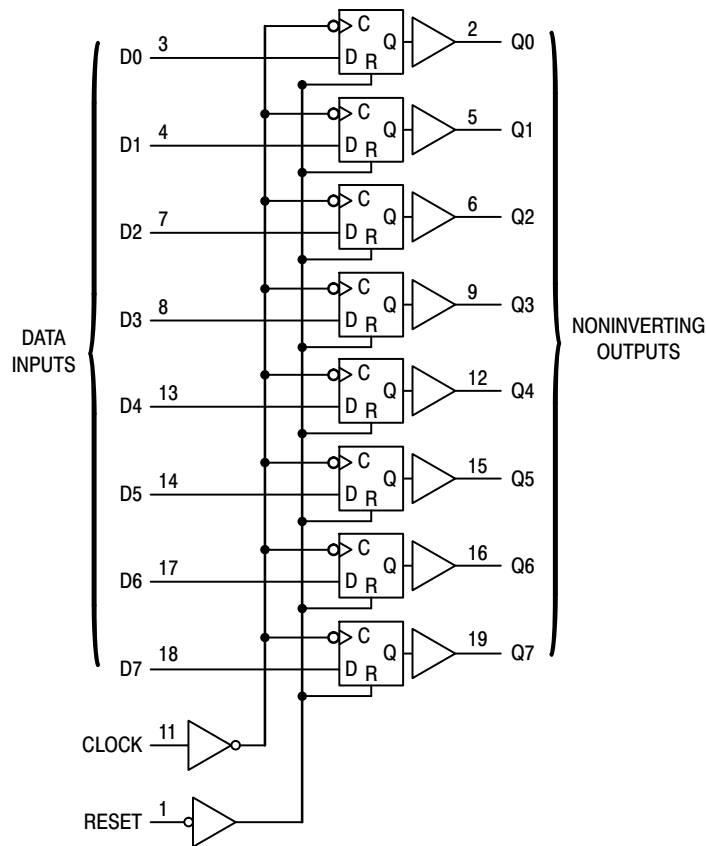


Figure 6. Expanded Logic Diagram

# MC74HCT273A

## ORDERING INFORMATION

| Device           | Package              | Shipping†          |
|------------------|----------------------|--------------------|
| MC74HCT273ANG    | PDIP-20<br>(Pb-Free) | 18 Units / Rail    |
| MC74HCT273ADWG   | SOIC-20<br>(Pb-Free) | 38 Units / Rail    |
| MC74HCT273ADWR2G | SOIC-20<br>(Pb-Free) | 1000 / Tape & Reel |
| MC74HCT273ADTR2G | TSSOP-20*            | 2500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

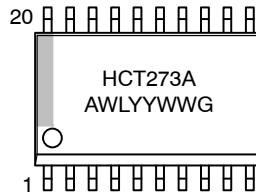
\*These packages are inherently Pb-Free.

## MARKING DIAGRAMS

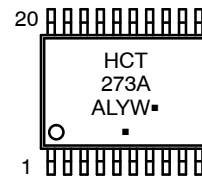
PDIP-20



SOIC-20W



TSSOP-20



A = Assembly Location

WL, L = Wafer Lot

YY, Y = Year

WW, W = Work Week

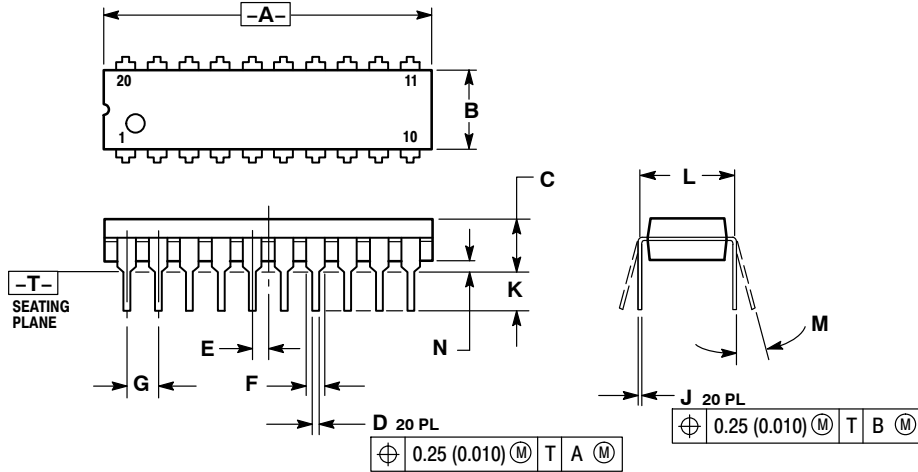
G or ▪ = Pb-Free Package

(Note: Microdot may be in either location)

# MC74HCT273A

## PACKAGE DIMENSIONS

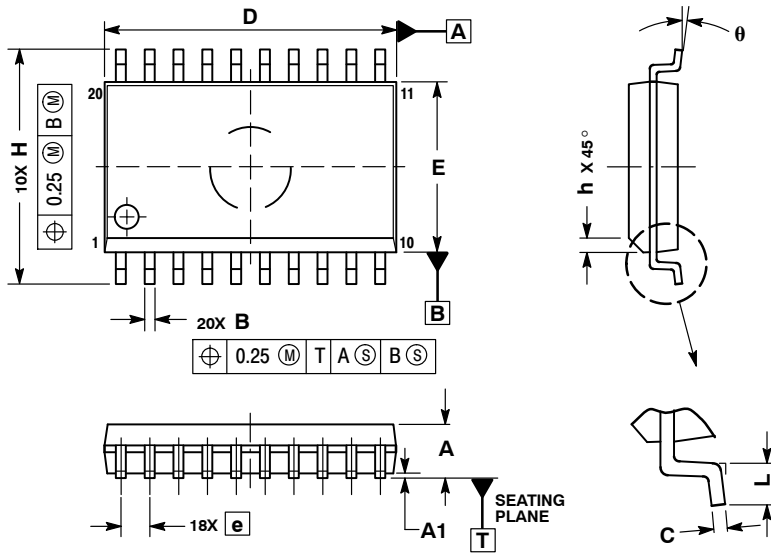
PDIP-20  
N SUFFIX  
PLASTIC DIP PACKAGE  
CASE 738-03  
ISSUE E



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 1.010     | 1.070 | 25.66       | 27.17 |
| B   | 0.240     | 0.260 | 6.10        | 6.60  |
| C   | 0.150     | 0.180 | 3.81        | 4.57  |
| D   | 0.015     | 0.022 | 0.39        | 0.55  |
| E   | 0.050 BSC |       | 1.27 BSC    |       |
| F   | 0.050     | 0.070 | 1.27        | 1.77  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.110     | 0.140 | 2.80        | 3.55  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 15°   | 0°          | 15°   |
| N   | 0.020     | 0.040 | 0.51        | 1.01  |

SOIC-20W  
DW SUFFIX  
CASE 751D-05  
ISSUE G



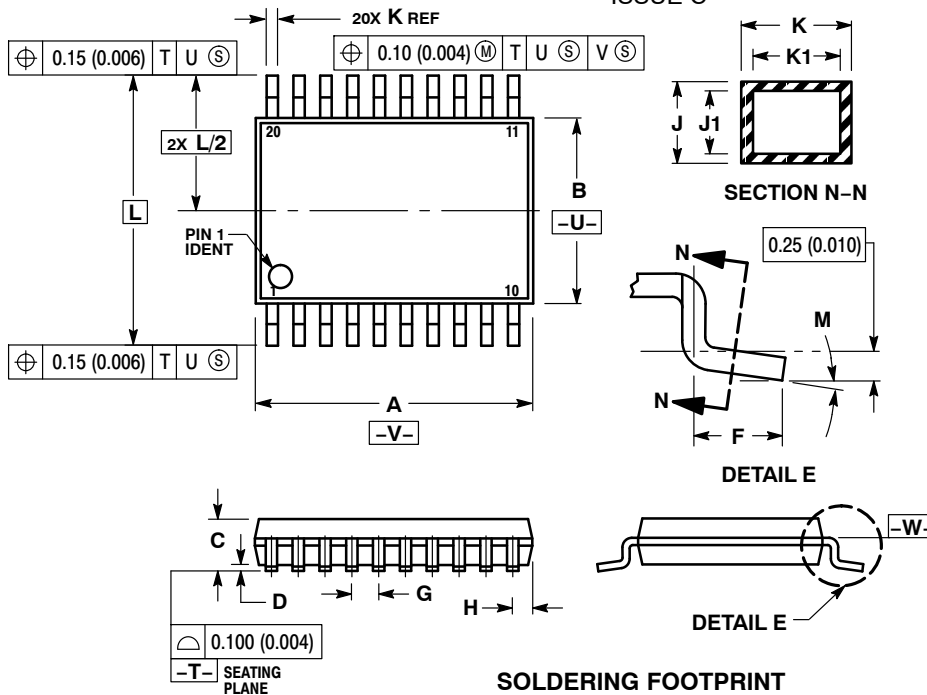
- NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
  2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
  5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       |
|-----|-------------|-------|
|     | MIN         | MAX   |
| A   | 2.35        | 2.65  |
| A1  | 0.10        | 0.25  |
| B   | 0.35        | 0.49  |
| C   | 0.23        | 0.32  |
| D   | 12.65       | 12.95 |
| E   | 7.40        | 7.60  |
| e   | 1.27 BSC    |       |
| H   | 10.05       | 10.55 |
| h   | 0.25        | 0.75  |
| L   | 0.50        | 0.90  |
| θ   | 0°          | 7°    |

# MC74HCT273A

## PACKAGE DIMENSIONS

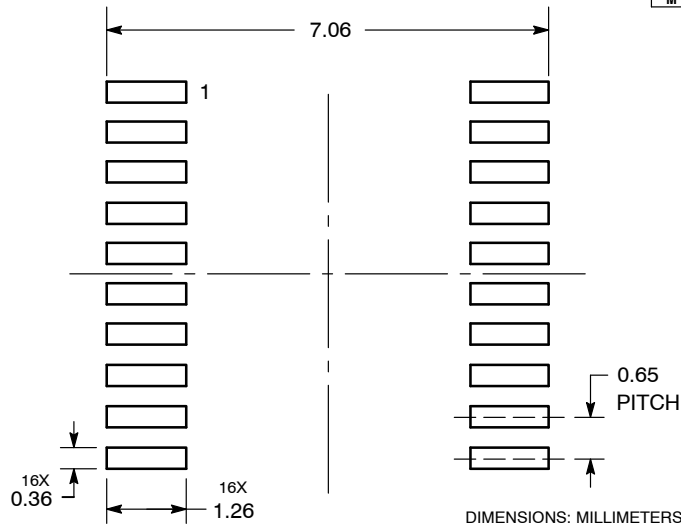
TSSOP-20  
DT SUFFIX  
CASE 948E-02  
ISSUE C



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 6.40        | 6.60 | 0.252     | 0.260 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.27        | 0.37 | 0.011     | 0.015 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |



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- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
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## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

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«FORSTAR» (основан в 1998 г.)

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